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Part Number:

0780350001

Status:

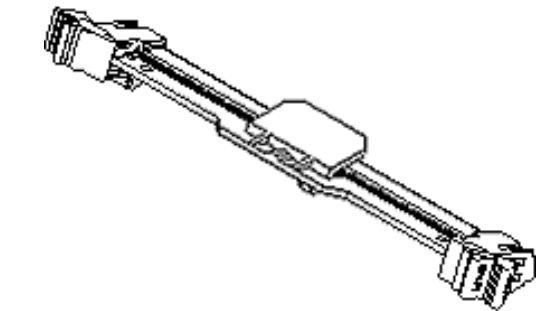
Active

Overview:

MiniDIMM Sockets

Description:

0.60mm Pitch miniDIMM DDR2 Socket, Surface Mount, 22.5° Reverse Angle, 0.76µm Gold (Au) Plating, Off-White Latches, with Pick-and-Place Cap, 244 Circuits, 1.8V Voltage Key, Lead-Free



Series image - Reference only

Documents:	
3D Model	Application Specification AS-87782-001-001 (PDF)
Drawing (PDF)	Packaging Specification PK-78035-001 (PDF)
Product Specification PS-78035-001-001 (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR19980
UL	E29179
Application tooling part link	
Application Tooling Part Link	62100-1960
General	
Product Family	Memory Module Sockets
Series	78035
Component Type	Socket
Electrical Model	Yes
JEDEC Outline	MO-244
Overview	MiniDIMM Sockets
Product Name	MiniDIMM
UPC	822350247795
Physical	
Circuits (Loaded)	244
Durability (mating cycles max)	25
Entry Angle	22.5° Angle
Flammability	94V-0
Housing Color	Black
Keying to Mating Part	Yes
Latch Color	Natural (Off-White)
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	6.050/g
PCB Locator	Yes
PCB Retention	Yes
Packaging Type	Tray
Pitch - Mating Interface	0.60mm
Plating min - Mating	0.762µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-10° to +85°C
Termination Interface: Style	Surface Mount
Electrical	
Current - Maximum per Contact	1.0A
Voltage - Maximum	30V
Voltage Key	1.8V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	005

EU ELV

Not Relevant

EU RoHS

Compliant

China RoHS

REACH SVHC

Not Contained Per -
ED/71/2019 (16 July
2019)

Halogen-Free

Status

Not Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

Green Image

ELV

Not Relevant

RoHS Phthalates

Not Contained

Search Parts in this Series

[78035](#) Series

Mates With

JEDEC MO-244 Modules

Application Tooling | [FAQ](#)

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description

Product #

MiniDIMM Memory

[621001960](#)

Card Insertion Tool

Lead-freeProcess Capability	REFLOW
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Application Specification	AS-87782-001-001
Electrical Model Document	EE-78035-001
Packaging Specification	PK-78035-001
Product Specification	PS-78035-001-001
S-Parameter Model	SP-78035-001
Sales Drawing	SD-78035-001

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